74LVC2G125

Dual bus buffer/line driver; 3-state

Rev. 18 — 16 August 2023

Product data sheet

1. General description

The 74LVC2G125 is a dual buffer/line driver with 3-state outputs controlled by the output enable inputs (nOE). Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- I_{OFF} circuitry provides partial Power-down mode operation
- ±24 mA output drive (V_{CC} = 3.0 V)
- CMOS low-power consumption
- · Latch-up performance exceeds 250 mA
- · Direct interface with TTL levels
- Overvoltage tolerant inputs to 5.5 V
- Complies with JEDEC standard:
- JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- · Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



Dual bus buffer/line driver; 3-state

3. Ordering information

Table 1. Ordering information

Type number	Package							
	Temperature range	Name	Description	Version				
74LVC2G125DP	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2				
74LVC2G125DC	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1				
74LVC2G125GT	-40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm	SOT833-1				
74LVC2G125GF	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1 × 0.5 mm	SOT1089				
74LVC2G125GN	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.2 × 1.0 × 0.35 mm	SOT1116				
74LVC2G125GS	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm	SOT1203				

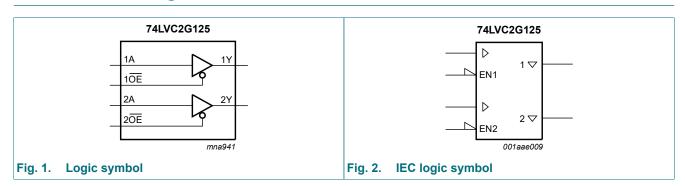
4. Marking

Table 2. Marking codes

Table 2. Marking codes						
Type number	Marking code [1]					
74LVC2G125DP	V25					
74LVC2G125DC	V25					
74LVC2G125GT	V25					
74LVC2G125GF	VM					
74LVC2G125GN	VM					
74LVC2G125GS	VM					

^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

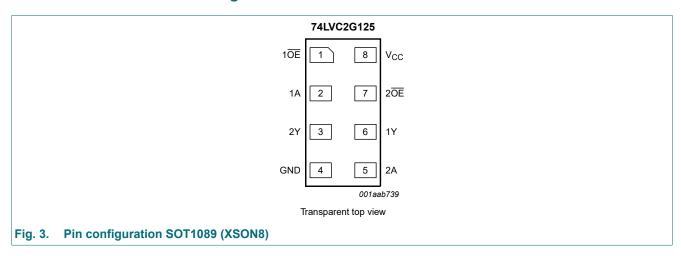
5. Functional diagram

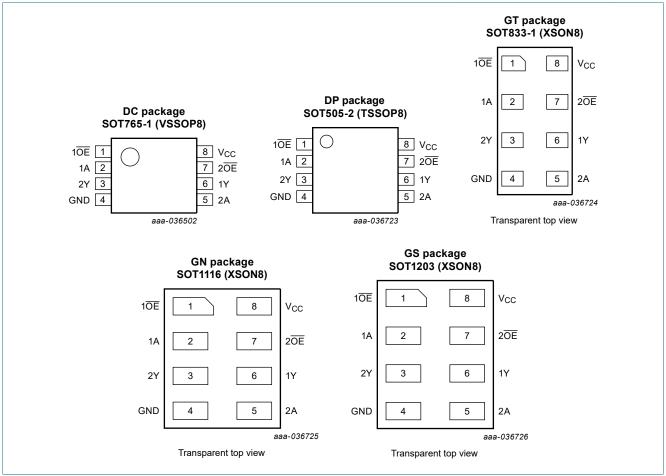


Dual bus buffer/line driver; 3-state

6. Pinning information

6.1. Pinning





Dual bus buffer/line driver; 3-state

6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
1 OE , 2 OE	1, 7	output enable input (active LOW)
1A, 2A	2, 5	data input
GND	4	ground (0 V)
1Y, 2Y	6, 3	data output
V _{CC}	8	supply voltage

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

	Input	Output
n OE	nA	nY
L	L	L
L	Н	Н
Н	X	Z

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage	[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
Vo	output voltage	Enable mode [1]	-0.5	V _{CC} + 0.5	V
		Disable mode [1]	-0.5	+6.5	V
		Power-down mode; V _{CC} = 0 V [1]	-0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ [2]	-	250	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^[2] For SOT505-2 (TSSOP8) package: P_{tot} derates linearly with 4.6 mW/K above 96 °C.

For SOT765-1 (VSSOP8) package: P_{tot} derates linearly with 4.9 mW/K above 99 °C.

For SOT833-1 (XSON8) package: P_{tot} derates linearly with 3.1 mW/K above 68 °C.

For SOT1089 (XSON8) package: Ptot derates linearly with 4.0 mW/K above 88 °C.

For SOT1116 (XSON8) package: Ptot derates linearly with 4.2 mW/K above 90 °C.

For SOT1203 (XSON8) package: P_{tot} derates linearly with 3.6 mW/K above 81 °C.

Dual bus buffer/line driver; 3-state

9. Recommended operating conditions

Table 6. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		1.65	5.5	V
Vı	input voltage		0	5.5	V
V _O output voltage	output voltage	V _{CC} = 1.65 V to 5.5 V; Enable mode	0	V _{CC}	V
		V _{CC} = 1.65 V to 5.5 V; Disable mode	0	5.5	V
		V _{CC} = 0 V; Power-down mode	0	5.5	V
T _{amb}	ambient temperature		-40	+125	°C
Δt/ΔV ii	input transition rise and fall rate	V _{CC} = 1.65 V to 2.7 V	-	20	ns/V
		V _{CC} = 2.7 V to 5.5 V	-	10	ns/V

Dual bus buffer/line driver; 3-state

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.65 V to 1.95 V	0.65V _{CC}	-	-	0.65V _{CC}	-	V
	input voltage	V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
		V _{CC} = 4.5 V to 5.5 V	0.7V _{CC}	-	-	0.7V _{CC}	-	V
V _{IL}	LOW-level	V _{CC} = 1.65 V to 1.95 V	-	-	0.35V _{CC}	-	0.35V _{CC}	V
	input voltage	V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3V _{CC}	-	0.3V _{CC}	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	I _O = 100 μA; V _{CC} = 1.65 V to 5.5 V	-	-	0.1	-	0.1	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.70	V
		I _O = 8 mA; V _{CC} = 2.3 V	-	-	0.3	-	0.45	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.4	-	0.60	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.55	-	0.80	V
		I _O = 32 mA; V _{CC} = 4.5 V	-	-	0.55	-	0.80	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}						
	output voltage	I _O = -100 μA; V _{CC} = 1.65 V to 5.5 V	V _{CC} - 0.1	-	-	V _{CC} - 0.1	-	V
		I _O = -4 mA; V _{CC} = 1.65 V	1.2	-	-	0.95	-	V
		I_{O} = -8 mA; V_{CC} = 2.3 V	1.9	-	-	1.7	-	V
		I _O = -12 mA; V _{CC} = 2.7 V	2.2	-	-	1.9	-	V
		I _O = -24 mA; V _{CC} = 3.0 V	2.3	-	-	2.0	-	V
		I _O = -32 mA; V _{CC} = 4.5 V	3.8	-	-	3.4	-	V
I _I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	±0.1	±1	-	±1	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_O = 5.5$ V or GND; $V_{CC} = 3.6$ V	-	±0.1	±2	-	±2	μΑ
I _{OFF}	power-off leakage current	V_{I} or $V_{O} = 5.5 \text{ V}$; $V_{CC} = 0 \text{ V}$	-	±0.1	±2	-	±2	μΑ
I _{CC}	supply current	V _I = 5.5 V or GND; V _{CC} = 1.65 V to 5.5 V; I _O = 0 A	-	0.1	4	-	4	μΑ
ΔI _{CC}	additional supply current	per pin; $V_I = V_{CC} - 0.6 \text{ V}$; $I_O = 0 \text{ A}$; $V_{CC} = 2.3 \text{ V}$ to 5.5 V	-	5	500	-	500	μΑ
Cı	input capacitance		-	2	-	-	-	pF

^[1] Typical values are measured at V_{CC} = 3.3 V and at T_{amb} = 25 °C.

Dual bus buffer/line driver; 3-state

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground 0 V); for test circuit see Fig. 6.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	
t _{pd}	propagation	nA to nY; see Fig. 4 [2]						
	delay	V _{CC} = 1.65 V to 1.95 V	1.0	3.7	9.1	1.0	11.4	ns
		V _{CC} = 2.3 V to 2.7 V	0.5	2.5	4.8	0.5	6.0	ns
		V _{CC} = 2.7 V	1.0	2.7	4.8	1.0	6.0	ns
		V _{CC} = 3.0 V to 3.6 V	0.5	2.3	4.3	0.5	5.5	ns
		V _{CC} = 4.5 V to 5.5 V	0.5	1.9	3.7	0.5	4.6	ns
t _{en}	enable time	nOE to nY; see Fig. 5 [3]						
		V _{CC} = 1.65 V to 1.95 V	1.5	4.3	9.9	1.5	12.4	ns
		V _{CC} = 2.3 V to 2.7 V	1.0	2.8	5.6	1.0	7.0	ns
		V _{CC} = 2.7 V	1.5	3.3	5.7	1.5	7.1	ns
		V _{CC} = 3.0 V to 3.6 V	0.5	2.4	4.7	0.5	5.9	ns
		V _{CC} = 4.5 V to 5.5 V	0.5	2.0	3.8	0.5	4.8	ns
t _{dis}	disable time	nOE to nY; see Fig. 5 [4]						
		V _{CC} = 1.65 V to 1.95 V	1.0	3.5	11.6	1.0	14.1	ns
		V _{CC} = 2.3 V to 2.7 V	0.5	1.8	5.8	0.5	7.6	ns
		V _{CC} = 2.7 V	1.0	2.7	4.8	1.0	6.2	ns
		V _{CC} = 3.0 V to 3.6 V	1.0	2.7	4.6	1.0	5.9	ns
		V _{CC} = 4.5 V to 5.5 V	0.5	1.8	3.4	0.5	4.6	ns
C _{PD}	1:	per buffer; V_I = GND to V_{CC} [5]						
	capacitance	output enabled	-	18	-	-	-	pF
		output disabled	-	5	-	-	-	pF

^[1] Typical values are measured at nominal V_{CC} and at T_{amb} = 25 °C.

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

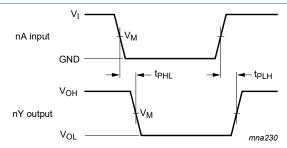
^[3] t_{en} is the same as t_{PZH} and t_{PZL} .

^[4] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

^[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

Dual bus buffer/line driver; 3-state

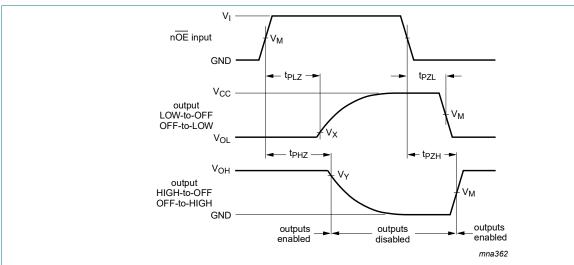
11.1. Waveforms and test circuit



Measurement points are given in Table 9.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 4. Propagation delay input (nA) to output (nY)



Measurement points are given in Table 9.

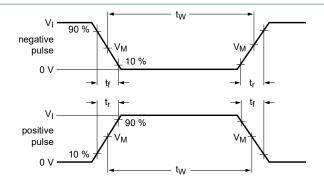
Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

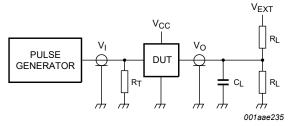
Fig. 5. 3-state output enable and disable times

Table 9. Measurement points

Supply voltage	Input	Output	Output				
V _{CC}	V _M	V _M	V _X	V _Y			
1.65 V to 1.95 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V			
2.3 V to 2.7 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V			
2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V			
3.0 V to 3.6 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V			
4.5 V to 5.5 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.3 V	V _{OH} - 0.3 V			

Dual bus buffer/line driver; 3-state





Test data is given in <u>Table 10</u>.

Definitions for test circuit:

R_L = Load resistor;

C_L = Load capacitance including jig and probe capacitance;

 R_{T} = Termination resistance should be equal to output impedance Z_{o} of the pulse generator;

V_{EXT} = Test voltage for switching times.

Fig. 6. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input		Load	Load		V _{EXT}		
V _{CC}	V _I	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	
1.65 V to 1.95 V	V _{CC}	≤ 2.0 ns	30 pF	1 kΩ	open	GND	2V _{CC}	
2.3 V to 2.7 V	V _{CC}	≤ 2.0 ns	30 pF	500 Ω	open	GND	2V _{CC}	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	6 V	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	6 V	
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	open	GND	2V _{CC}	

Dual bus buffer/line driver; 3-state

12. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

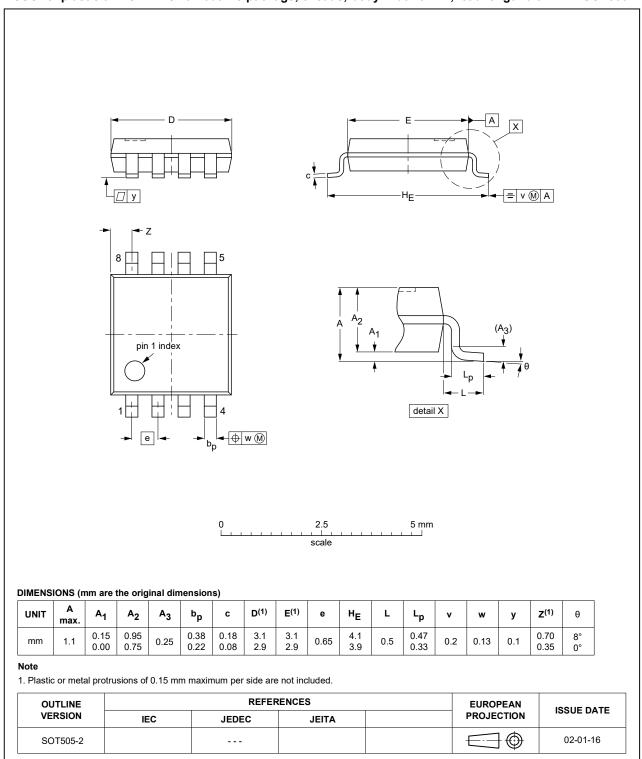


Fig. 7. Package outline SOT505-2 (TSSOP8)

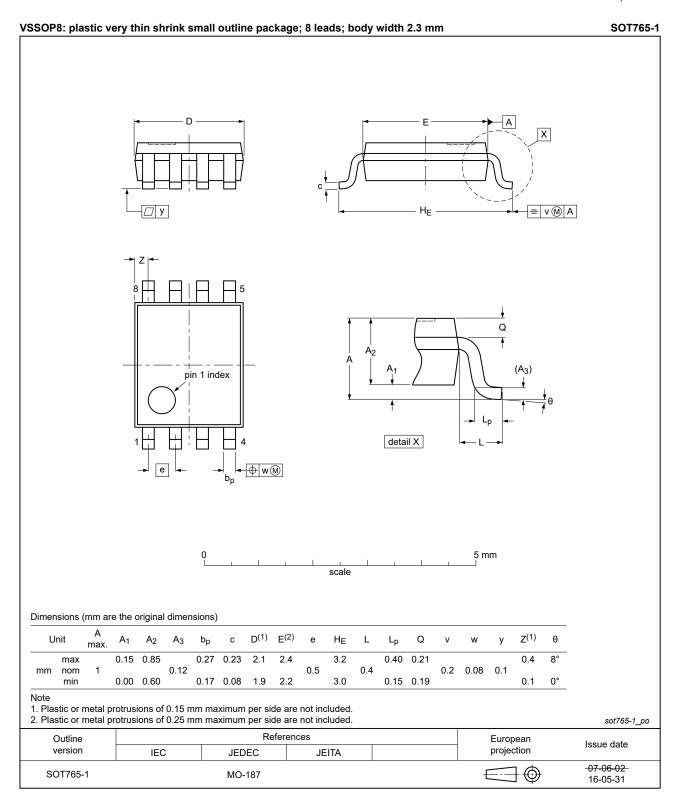


Fig. 8. Package outline SOT765-1 (VSSOP8)

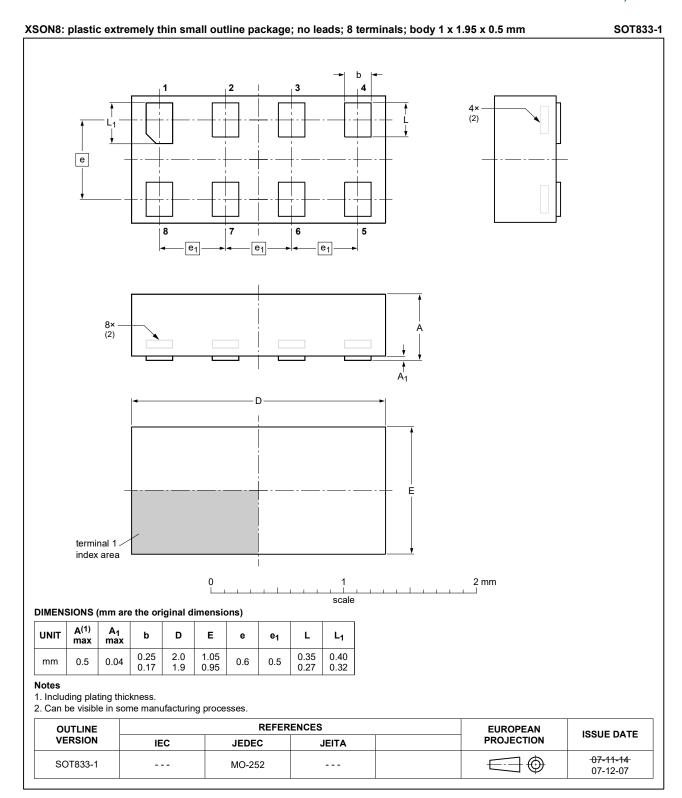


Fig. 9. Package outline SOT833-1 (XSON8)

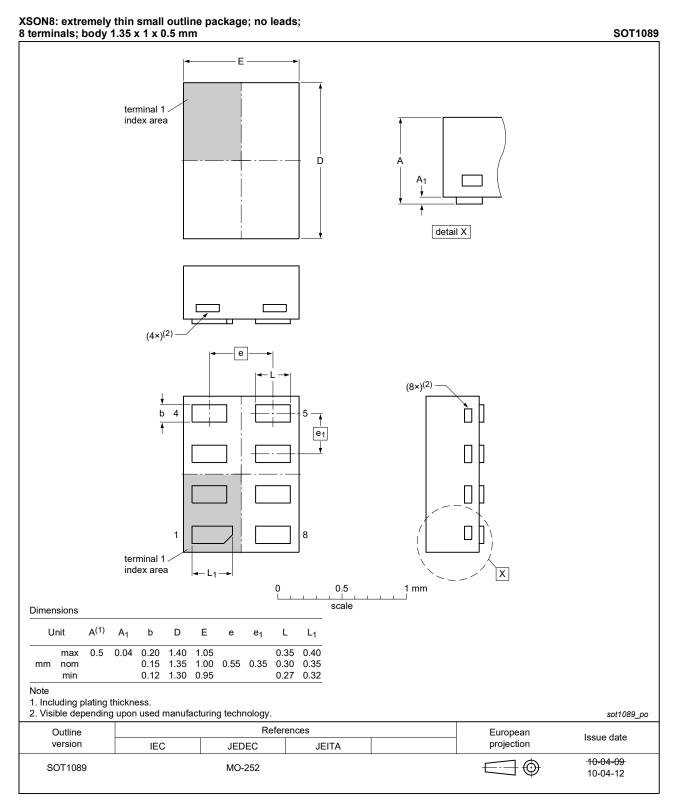


Fig. 10. Package outline SOT1089 (XSON8)

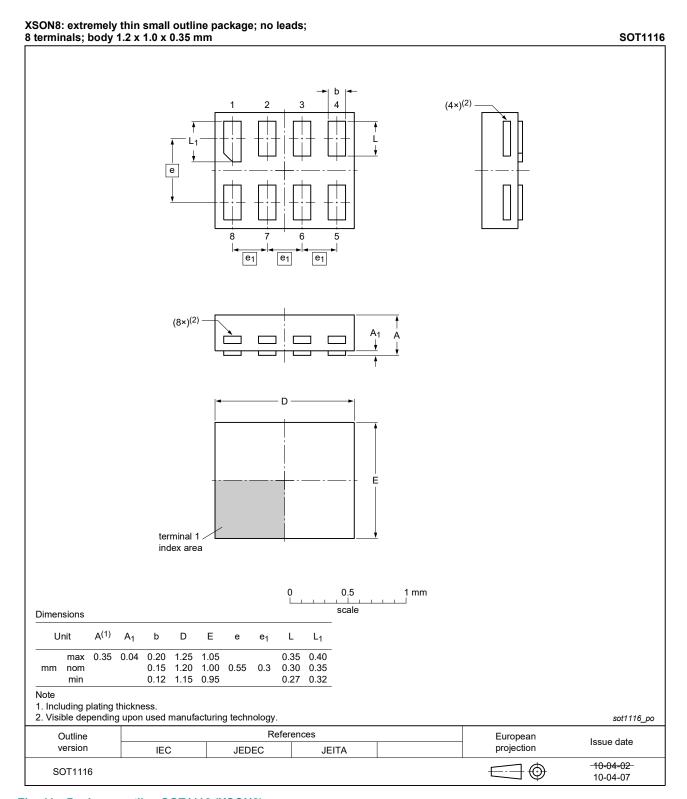


Fig. 11. Package outline SOT1116 (XSON8)

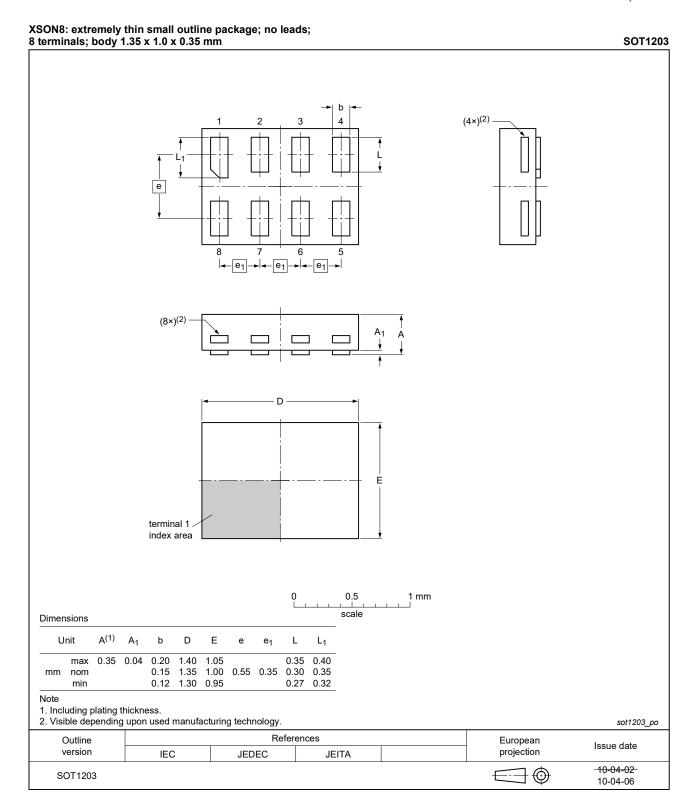


Fig. 12. Package outline SOT1203 (XSON8)

Dual bus buffer/line driver; 3-state

13. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
74LVC2G125 v.18	20230816	Product data sheet	-	74LVC2G125 v.17				
Modifications:	• <u>Section 2</u> : ES	SD specification updated a	cording to the lat	est JEDEC standard.				
74LVC2G125 v.17	20210726	Product data sheet	-	74LVC2G125 v.16				
Modifications:	Section 1 and	 Type number 74LVC2G125GM (SOT902-2/XQFN8) removed. Section 1 and Section 2 updated. Section 8: Derating values for Ptot total power dissipation updated. 						
74LVC2G125 v.16	20180910	Product data sheet	-	74LVC2G125 v.15				
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type numbers 74LVC2G125GD and (SOT996-2) removed. 							
74LVC2G125 v.15	20161215	Product data sheet	-	74LVC2G125 v.14				
Modifications:	• <u>Table 7</u> : The	maximum limits for leakage	e current and sup	ply current have changed.				
74LVC2G125 v.14	20130329	Product data sheet	-	74LVC2G125 v.13				
Modifications:	For type num	nber 74LVC2G125GD XSO	N8U has changed	d to XSON8.				
74LVC2G125 v.13	20120622	Product data sheet	-	74LVC2G125 v.12				
Modifications:	 For type num 	nber 74LVC2G125GM the S	SOT code has cha	anged to SOT902-2.				
74LVC2G125 v.12	20111201	Product data sheet	-	74LVC2G125 v.11				
Modifications:	 Legal pages 	updated.						
74LVC2G125 v.11	20100909	Product data sheet	-	74LVC2G125 v.10				
74LVC2G125 v.10	20080611	Product data sheet	-	74LVC2G125 v.9				
74LVC2G125 v.9	20080226	Product data sheet	-	74LVC2G125 v.8				
74LVC2G125 v.8	20070907	Product data sheet	-	74LVC2G125 v.7				
74LVC2G125 v.7	20060523	Product data sheet	-	74LVC2G125 v.6				
74LVC2G125 v.6	20051223	Product data sheet	-	74LVC2G125 v.5				
74LVC2G125 v.5	20050201	Product specification	-	74LVC2G125 v.4				
74LVC2G125 v.4	20040922	Product specification	-	74LVC2G125 v.3				
74LVC2G125 v.3	20040109	Product specification	-	74LVC2G125 v.2				
74LVC2G125 v.2	20030901	Product specification	-	74LVC2G125 v.1				

Product data sheet

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC2G125 v.1	20030310	Product specification	-	-

Dual bus buffer/line driver; 3-state

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- 2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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Dual bus buffer/line driver; 3-state

Contents

1. General description	1
2. Features and benefits	1
3. Ordering information	2
4. Marking	2
5. Functional diagram	2
6. Pinning information	3
6.1. Pinning	3
6.2. Pin description	4
7. Functional description	4
8. Limiting values	4
9. Recommended operating conditi	ons5
10. Static characteristics	6
11. Dynamic characteristics	7
11.1. Waveforms and test circuit	8
12. Package outline	10
13. Abbreviations	16
14. Revision history	16
15. Legal information	18

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